LVF-10 — TWO PART LIQUID VOID FILLER DATASHEET





PRODUCT OVERVIEW

• A two-part silicone-based liquid with heat conducting filler and binding materials. When the compound is mixed and cured it acts as a thermally conductive void filling material.

FEATURES

- · Good Thermal Conductivity
- Excellent Dielectric Performance
- · Long Life Span
- Weather Resistance.
- · Low Mechanical Stress
- Vibration and Shock Absorbance Properties

APPLICATIONS

• Electronic assemblies, thermistors, temperature sensors, power modules.

PROPERTIES	UNIT	LVF-10	TEST METHOD	
Colour	-	Part A: White Part B: Grey	Visual	
Thermal Conductivity (±10%)	W/mK	1.0	ASTM D5470	
Viscosity (Mixed)	Pa	20-50	ASTM D2196	
Breakdown Voltage (1mm)	KV	≥5	ASTM D149	
Specific Gravity	g/cm³	1.88	ASTM 5740	
Working Temperature	°C	-40 to 180	EM344	
Volume Resistance	Ohm-cm	≥10 ¹²	ASTM D257	
Flammability Rating	-	VO	UL 94	
Hardness (±5) Hardness, Thirty second delay (±5)	Shore 00 Shore 00	50 25	ASTM D412 ASTM D412	
Surface Drying Time (25°C)	min	20-30	-	
Curing Time (25°C) Curing Time (60°C) Curing Time (100°C)	min min min	≥50 10-15 5-10	- - -	

NOTES

- · Customised shapes are available
- ${}^{\textstyle \bullet}$ The above performance data is tested in an environment of 70% humidity, temperature 25 ${}^{\textstyle \circ}{\rm C}$
- This data is intended for reference purposes only. It is recommended that the material is tested to fully evaluate its performance ensuring it is fit for purpose.

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